1	2	3	4	5	6	
A						А
	SNS 0 V - 36 V	VIN 0 V - 3	6 V	VPU 0 V - 28 V		
B	J6 VIN VIN 2.00M TP5 R2 6.81k	TP3 TP3 TP3 TP3 TP3 U1 GND S VDD NA+ OUTA 1 TP4 TP4	J3 TP1 R6 0 DNP	-R5 ₹100k		В
C	R3 30.9k	4 INB- OUTB 6 GND 2 TPS3701DDCR G		TP2		с
D						D
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